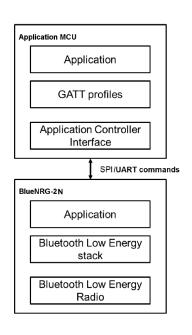


The BlueNRG-2N Bluetooth LE stack image package



Product summary		
BlueNRG-2N Bluetooth LE stack image package	STSW-BNRG2N- V320, STSW- BNRG2N-V330, STSW-BNRG2N- V340	
Bluetooth® Low Energy/ wireless system-on- chip	BlueNRG-2N	
BlueNRG-1,2 SW development package	STSW-BLUENRG1- DK	
Evaluation platform	X-NUCLEO- BNRG2A1	
Applications	wireless connectivity	

Features

- Firmware image for use with upgradable BlueNRG-2N Bluetooth[®] Low Energy network processor
- Provided in binary format only, as it is not intended to be modified

Description

The package contains a Bluetooth Low Energy stack firmware image supporting the upgradable BlueNRG-2N Bluetooth[®] Low Energy network processor, which is a low power Bluetooth Smart IC, compliant with the Bluetooth specification.

The image is provided in two formats:

- *.c: suitable for device firmware reprogramming during volume manufacturing of customer boards.
- *.bin: suitable for device firmware programming on-bench with the ST GUI for prototype bring-up, and also for device firmware reprogramming during volume manufacturing of customer boards.

It supports SPI or UART interfaces, selected through GPIO.

The device comes pre-programmed with a production-ready stack image, the version of which may change at any time without notice. The software version of the preloaded stack image can be retrieved through a specific API command (refer to the SDK documentation for further details). ST may in the future make new stack image firmware available to end users, free-of-charge, through www.st.com. End users can then upgrade parts with the newly downloaded stack image through the software tools and reference code provided by ST. Firmware is provided in compiled form, since it is not intended for modification by users.

The following Bluetooth Low Energy stack image versions are provided within the BlueNRG-2N Buetooth LE stack image packages available on the STMicroelectronics web page:

- 1. STSW-BNRG2N-V320: Bluetooth LE stack version 2.1c
- 2. STSW-BNRG2N-V330: Bluetooth LE stack version 2.1e
- 3. STSW-BNRG2N-V340: Bluetooth LE stack version 2.1f



Revision history

Table 1. Document revision history

Date	Version	Changes
28-Jul-2020	1	Initial release.
25-Oct-2021	2	Updated Section Description with reference to new STSW-BNRG2N-V330.
20-Dec-2022	3	Updated Product summary table and Section Description section with reference to new STSW-BNRG2N-V340.

DB4238 - Rev 3 page 2/3



IMPORTANT NOTICE - READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgment.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. For additional information about ST trademarks, refer to www.st.com/trademarks. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2022 STMicroelectronics - All rights reserved

DB4238 - Rev 3 page 3/3